







IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:

Wayne Renken

Assignee:

SensArray Corporation

Title:

Process Condition Sensing Wafer and Data Analysis System

Application No.:

10/056,906

Filing Date:

January 24, 2002

Examiner:

Garber, Charles D.

Group Art Unit:

2856

Docket No.:

SENS.005US0

Conf. No.:

2359

(formerly M-12467 US)

Certificate of Mailing Under 37 CFR 1.8

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope address to: Mail Stop Non-Fee Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on May 8, 2003

May 5 Buyes

Mail Stop Non-Fee Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

RESPONSE TO OFFICE ACTION

Sir:

In response to the Office Action dated April 8, 2003, claims 1-20 and 44 of Group I are hereby elected for examination in the present application, without traverse.

Respectfully submitted,

Gerald P. Parsons

May 8, 2003

Date

Reg. No. 24,486

DADCONIC HOLLE & DI

PARSONS HSUE & DE RUNTZ LLP 655 Montgomery Street, Suite 1800

San Francisco, CA 94111

(415) 318-1160

(415) 693-0194 fax